

Structure : Silicon Monolithic Integrated Circuit  
 Product Name : Power Driver For Compact Disc Players

Device Name : **BA5947FM**

- Features :
- 4-ch BTL driver
  - Use of an HSOP-M28 power package can achieve downsizing of the set.
  - 3 channels are directly connected to the PWM input. (with a built-in primary filter)
  - For CH4, the input terminal can be switched by the SW terminal.
  - A wide dynamic range (5.4V(typ.) when PreVcc=PowVcc=8V and RL=8Ω)
  - A built-in thermal shutdown circuit is installed.
  - PreVcc, PowVcc of CH1 and CH2, and PowVcc of CH3 and CH4 are provided with power supplies independently and an efficient power supply voltage design can be achieved.
  - Using an external mute terminal, the output current can be muted.
  - A built-in general operational amplifier installed.

○ ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Parameter	Symbol	Limits	Unit
Power Supply Voltage	Vcc	13.5	V
Power Dissipation	Pd	2.2 *1	W
Operating Temperature Range	Topr	-35 to 85	°C
Storage Temperature Range	Tstg	-55 to 150	°C

○ RECOMMENDED OPERATING CONDITIONS (To determine a power supply voltage, the power dissipation must be taken into consideration.)

PreVcc	6.0 to 13.2 V
PowVcc	6.0 to PreVcc

\*1 When mounted on the glass/epoxy board with the size: 70 mm×70 mm, the thickness: 1.6 mm, and the rate of copper foil occupancy area: 3% or less.  
 Over Ta=25°C, derating at the rate of 17.6mW/°C.

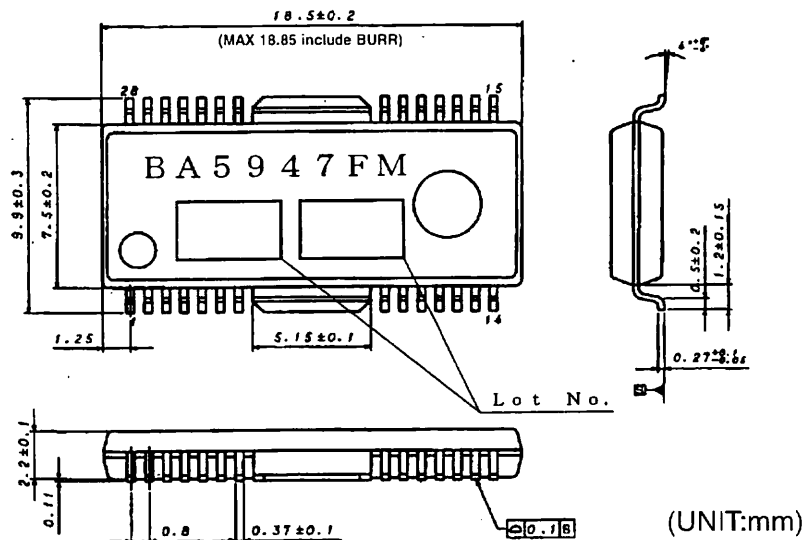
This product has not been checked for the strategic materials (or service) defined in the Foreign Exchange and Foreign Trade Control Law of Japan so that a verification work is required before exporting it.

Not designed for radiation resistance.

○ ELECTRIC CHARACTERISTICS (Ta=25°C, Vcc=8V, R<sub>L</sub>=8Ω, V<sub>b</sub>=VOP+=1.75V, unless otherwise noted.)

Parameter	Symbol	MIN	TYP	MAX	Unit	Condition
Consumption Current (at no signal)	I <sub>Q</sub>	-	17.0	25.0	mA	no load applied
internal Vref Terminal Voltage	VREF	3.40	3.70	4.00	V	
Mute OFF Voltage	V <sub>MON</sub>	1.9	-	-	V	
Mute ON Voltage	V <sub>MOFF</sub>	-	-	0.5	V	
Drivers not a spindle type (CH1, 2, 3)						
Input High-level Voltage	V <sub>IH</sub>	1.9	-	V <sub>CC</sub>	V	
Input Low-level Voltage	V <sub>IL</sub>	-0.3	-	0.5	V	
Input High-level Current	I <sub>IH</sub>	170	310	450	μA	V <sub>f</sub> =V <sub>r</sub> =5V
Input Low-level Current F side	I <sub>ILF</sub>	-10	-	0	μA	V <sub>f</sub> =0V
Input Low-level Current R side	I <sub>ILR</sub>	-50	-	0	μA	V <sub>r</sub> =0V
Output Offset Voltage	V <sub>OO</sub>	-30	-	30	mV	
Maximum Output Amplitude	V <sub>OM</sub>	4.4	5.0	5.6	V	V <sub>f</sub> =5V, V <sub>r</sub> =0V
Spindle Drivers (CH4)						
Input Bias Current	I <sub>B</sub>	-	10	300	nA	
Output Offset	V <sub>OO4</sub>	-50	-	50	mV	V <sub>IN4</sub> =V <sub>b</sub>
Maximum Output Amplitude	V <sub>OM</sub>	-	5.4	-	V	V <sub>b</sub> =4V
Voltage Gain 1	G <sub>VC1</sub>	9.3	11.3	13.3	dB	PIN24 and PIN25 are shorted.
Voltage Gain 2	G <sub>VC2</sub>	27.8	31.3	34.8	dB	PIN24 and PIN25 are shorted.
Analog SW Input						
Input High-level Voltage	V <sub>IHSW</sub>	1.9	-	V <sub>CC</sub>	V	
Input Low-level Voltage	V <sub>ILSW</sub>	-0.3	-	0.5	V	
Input High-level Current	I <sub>IHSW</sub>	-	60	90	μA	V <sub>SW</sub> =3.5V
Input Low-level Current	I <sub>ILSW</sub>	-10	0	10	μA	V <sub>SW</sub> =0V
Operational Amplifier						
Offset Voltage	V <sub>OFOP</sub>	-5	0	5	mV	
Input Bias Current	I <sub>BOP</sub>	-	10	300	nA	
High-level Output Voltage	V <sub>OHOP</sub>	7.0	-	-	V	
Low-level Output Voltage	V <sub>OLOP</sub>	-	-	0.2	V	
Output Driving Current Sink	I <sub>sink</sub>	2.0	9.0	-	mA	
Output Driving Current Source	I <sub>source</sub>	7.0	13.0	-	mA	
Open-loop Voltage Gain	G <sub>VO</sub>	-	65	-	dB	V <sub>IN</sub> =-60dBV, 1KHz
Slew Rate	SR	-	0.5	-	V/μs	f=50kHz, 2Vpp square wave, V <sub>b</sub> =4V

○ OUTLINE DIMENSIONS, SYMBOLS





○ CAUTIONS ON USE

- (1) Thermal shutdown or mute ON will activate the mute function only on the driver part.
- (2) Even though a radiating fin is connected to the GND inside of the package, it must be connected to the external GND.
- (3) About absolute maximum ratings  
Exceeding the absolute maximum ratings, such as the applied voltage or the operating temperature range, may cause permanent device damage. As these cases cannot be limited to the broken short mode or the open mode, if a special mode where the absolute maximum ratings may be exceeded is assumed, it is recommended to take mechanical safety measures such as attaching fuses.
- (4) About power supply lines  
As a measure against the back current regenerated by a counter electromotive force of the motor, a capacitor to be used as a regenerated-current path can be installed between the power supply and GND and its capacitance value should be determined after careful check that any problems, for example, a leak capacitance of the electrolytic capacitor at low temperature, are not found in various characteristics.
- (5) About GND potential  
The electric potential of the GND terminal must be kept lowest in the circuitry at any operation states.
- (6) About thermal design  
With consideration of the power dissipation (Pd) under conditions of actual use, a thermal design provided with an enough margin should be done.
- (7) About operations in a strong electric field  
When used in a strong electric field, note that a malfunction may occur.
- (8) ASO  
When using this IC, the output Tr must be set not to exceed the values specified in the absolute maximum ratings and ASO.
- (9) Thermal shutdown circuit  
This IC incorporates a thermal shutdown circuit (TSD circuit). When the chip temperature reaches the value shown below, the coil output to the motor will be set to open.  
The thermal shutdown circuit is designed only to shut off the IC from a thermal runaway and not intended to protect or guarantee the entire IC functions.  
Therefore, users cannot assume that the TSD circuit once activated can be used continuously in the subsequent operations.

TSD ON Temperature [°C] (typ.)	Hysteresis Temperature [°C] (typ.)
180	20

- (10) About earth wiring patterns  
When a small signal GND and a large current GND are provided, it is recommended that the large current GND pattern and the small signal GND pattern should be separated and grounded at a single point of the reference point of the set in order to prevent the voltage of the small signal GND from being affected by a voltage change caused by the resistance of the pattern wiring and the large current. Make sure that the GND wiring patterns of the external components will not change, too.
- (11) This IC is a monolithic IC which has a P<sup>+</sup> isolations and P substrate to isolate elements each other. This P layer and an N layer in each element form a PN junction to construct various parasitic elements. Due to the IC structure, the parasitic elements are inevitably created by the potential relationship. Activation of the parasitic elements can cause interference between circuits and may result in a malfunction or, consequently, a fatal damage. Therefore, make sure that the IC must not be used under conditions that may activate the parasitic elements, for example, applying the lower voltage than the ground level (GND, P substrate) to the input terminals.  
Note that, while not applying the power supply voltage to the IC, any voltage must not be applied to the input terminals. In addition, do not apply the voltage to input terminals without applying the power supply voltage to the IC. Also while applying the power supply voltage, each input terminal must be the power supply voltage or less; or within the guaranteed values in the electric characteristics.

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